



US00D342071S

# United States Patent [19]

Wright et al.

[11] Patent Number: **Des. 342,071**

[45] Date of Patent: **\*\* Dec. 7, 1993**

[54] **HEADSET EARMUFF**  
[76] Inventors: **Gerald Wright; Lois Boykin**, both of  
1554 E. 61st Apt 2N, Chicago, Ill.  
60637

[\*\*] Term: **14 Years**

[21] Appl. No.: **788,729**

[22] Filed: **Nov. 6, 1991**

[52] U.S. Cl. .... **D14/223; D29/19**

[58] Field of Search ..... **D14/204-206,**  
**D14/223, 249; D29/19; 181/129; 379/430, 444;**  
**281/25, 68, 158, 183, 187; 2/209**

[56] **References Cited**

**U.S. PATENT DOCUMENTS**

|            |         |                  |       |         |
|------------|---------|------------------|-------|---------|
| D. 270,634 | 9/1983  | Ungar            | ..... | D14/205 |
| D. 292,331 | 10/1987 | Bryant           | ..... | D29/19  |
| D. 319,241 | 8/1991  | Daido et al.     | ..... | D14/205 |
| D. 328,074 | 7/1992  | Yamazaki et al.  | ..... | D14/205 |
| 961,765    | 6/1910  | Fassler          | ..... | D29/19  |
| 2,693,599  | 11/1954 | Berg             | ..... | D29/19  |
| 3,249,949  | 5/1966  | Rosenberg et al. | ..... | 2/209   |
| 4,546,215  | 10/1985 | Ferraro          | ..... | 2/209   |

|           |        |          |       |         |
|-----------|--------|----------|-------|---------|
| 4,571,746 | 2/1986 | Görke    | ..... | D29/19  |
| 4,654,898 | 4/1987 | Ishikawa | ..... | 2/209   |
| 4,669,129 | 6/1987 | Chance   | ..... | 2/209   |
| 4,689,822 | 8/1987 | Houng    | ..... | 381/183 |
| 5,095,382 | 3/1992 | Abe      | ..... | 381/25  |

**FOREIGN PATENT DOCUMENTS**

|         |        |                     |       |         |
|---------|--------|---------------------|-------|---------|
| 9010348 | 9/1990 | World Int. Prop. O. | ..... | 379/430 |
|---------|--------|---------------------|-------|---------|

*Primary Examiner*—Bernard Ansher  
*Assistant Examiner*—Sandra Morris  
*Attorney, Agent, or Firm*—Terry M. Gernstein

[57] **CLAIM**

The ornamental design for a headset earmuff, as shown and described.

**DESCRIPTION**

FIG. 1 is a perspective view of a headset earmuff showing our new design;  
FIG. 2 is a front elevational view thereof;  
FIG. 3 is a side elevational view thereof, the opposite side being a mirror image;  
FIG. 4 is a top plan view thereof; and,  
FIG. 5 is a bottom plan view thereof.



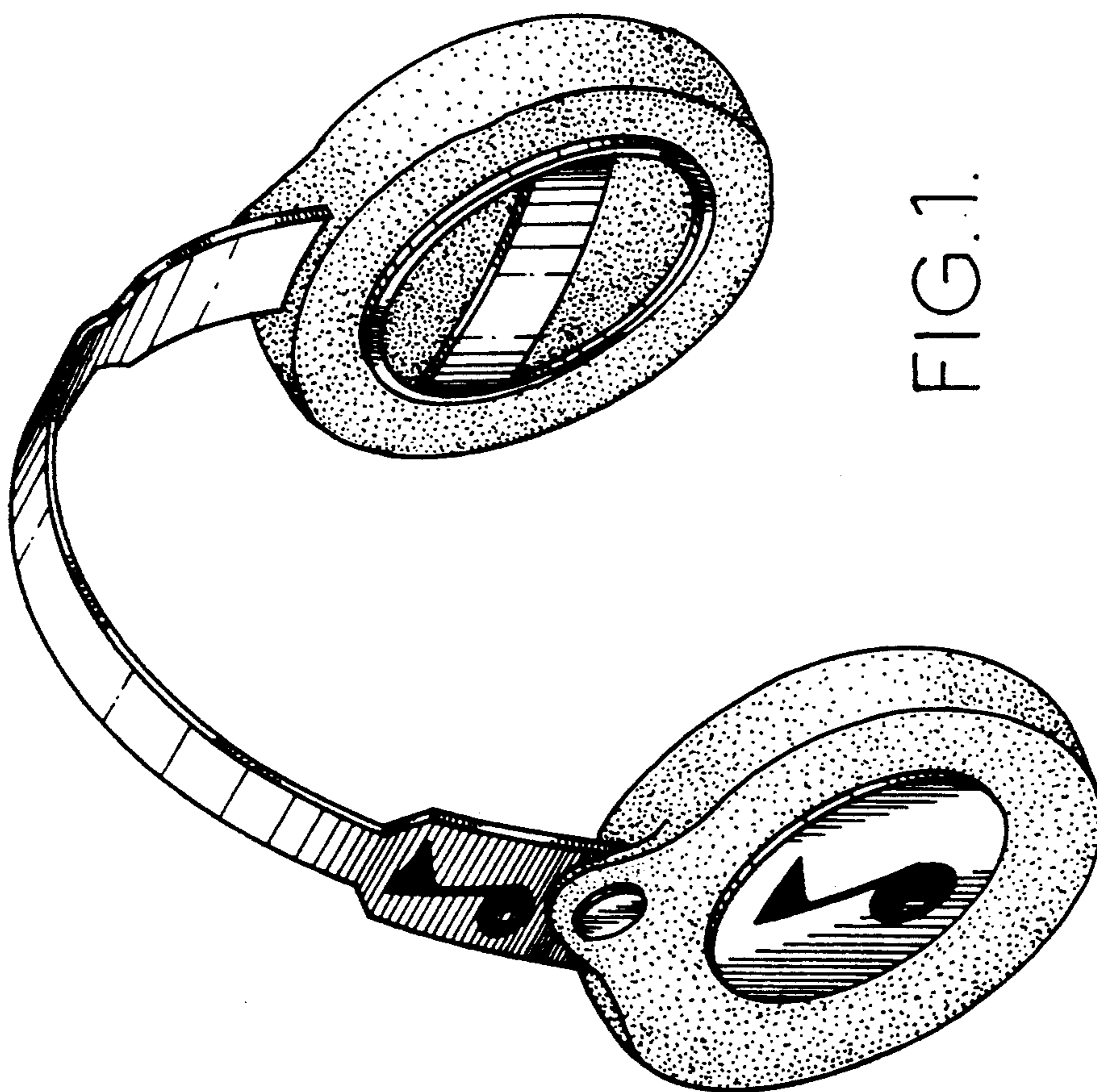


FIG. 1.

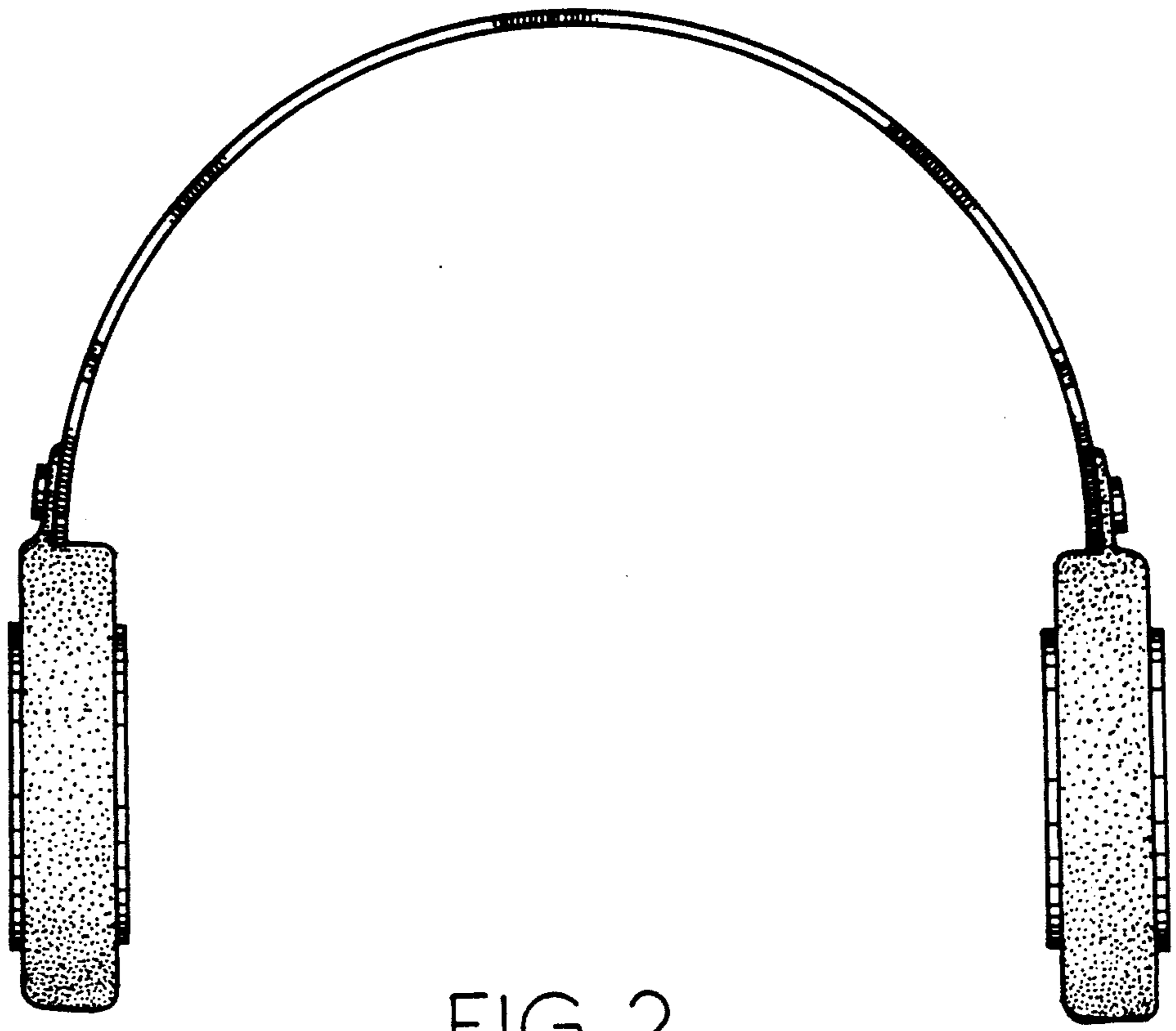


FIG. 2.

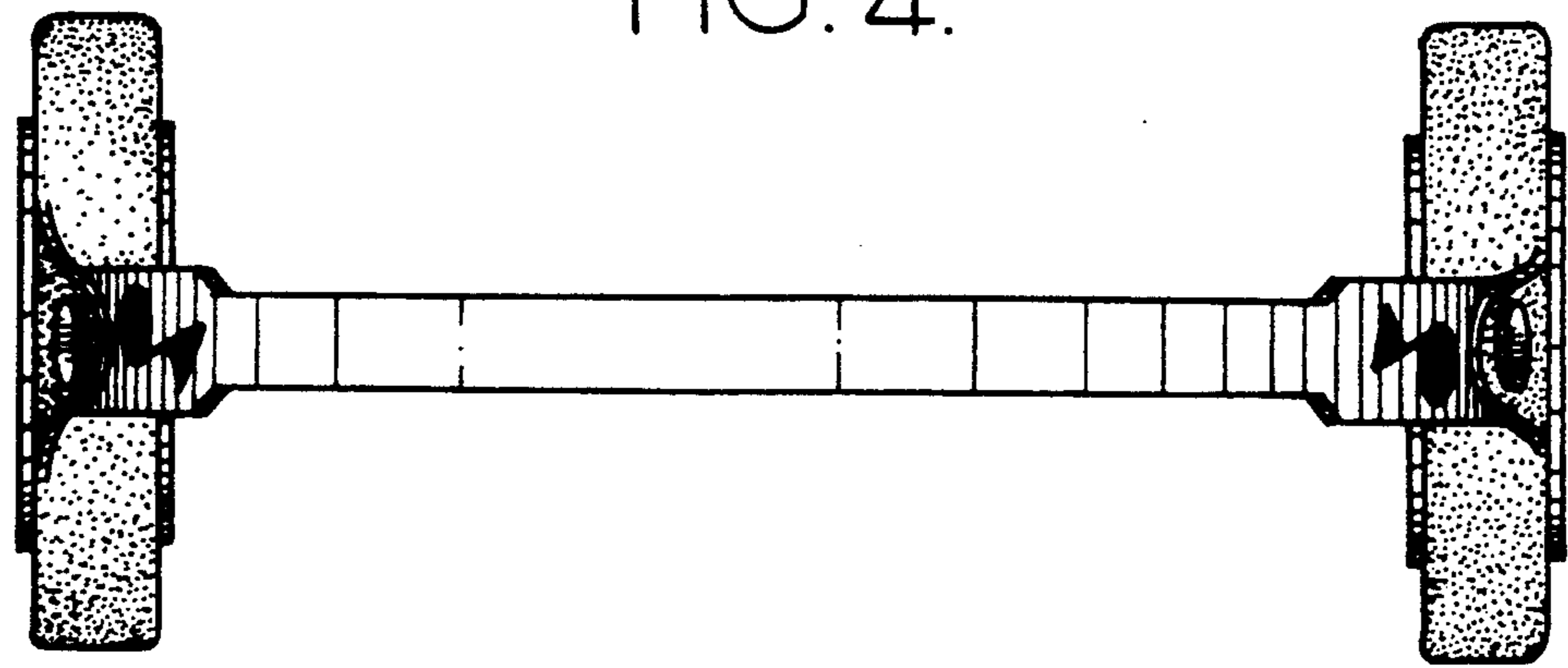


FIG. 4.

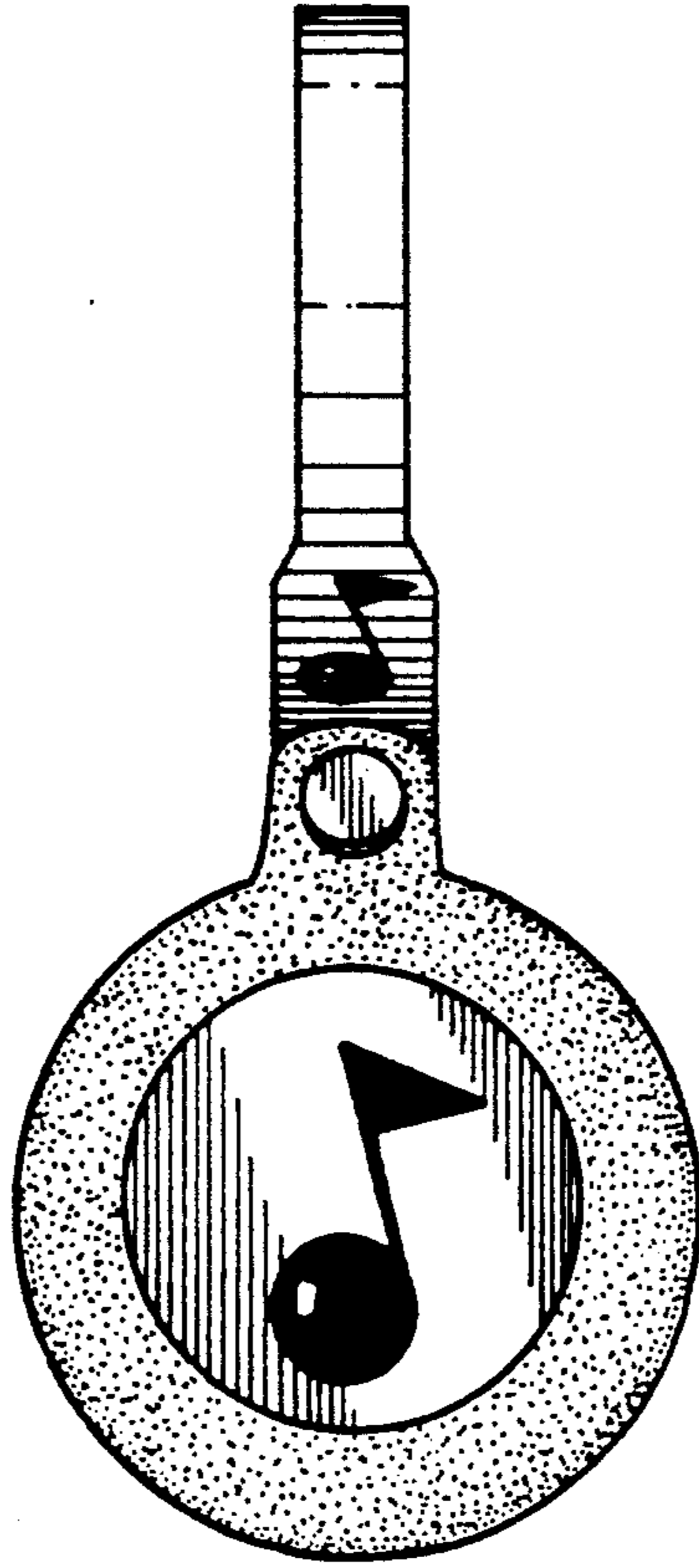


FIG. 3.

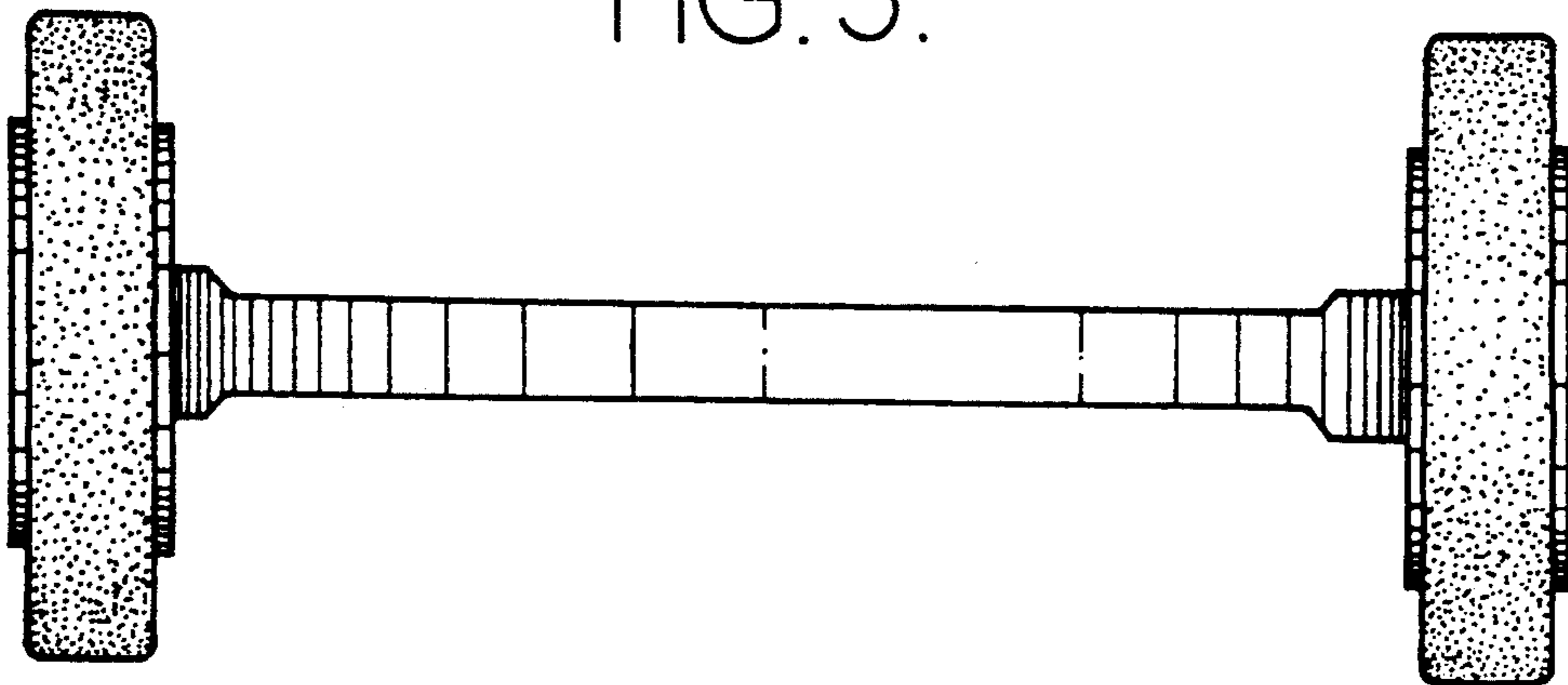


FIG. 5.